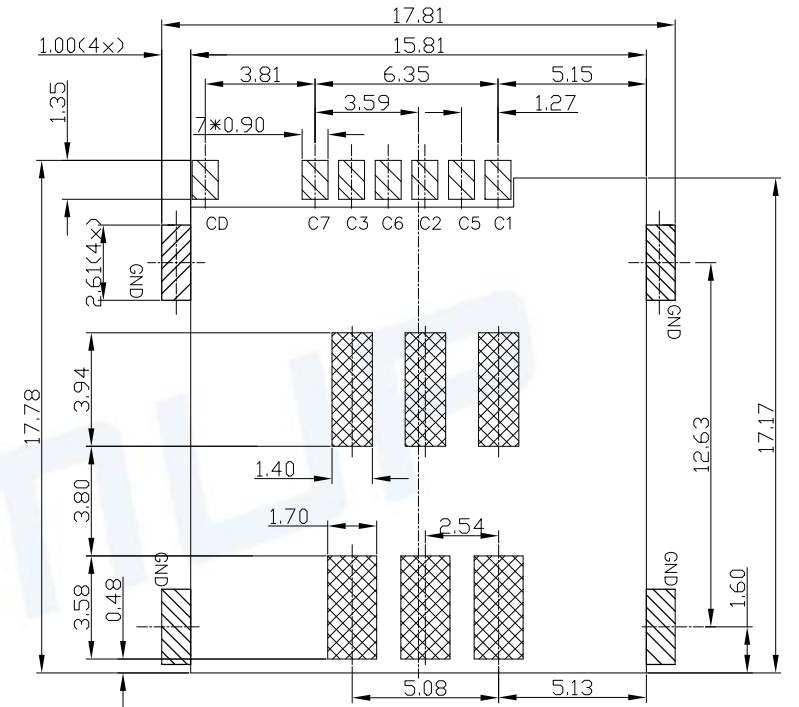
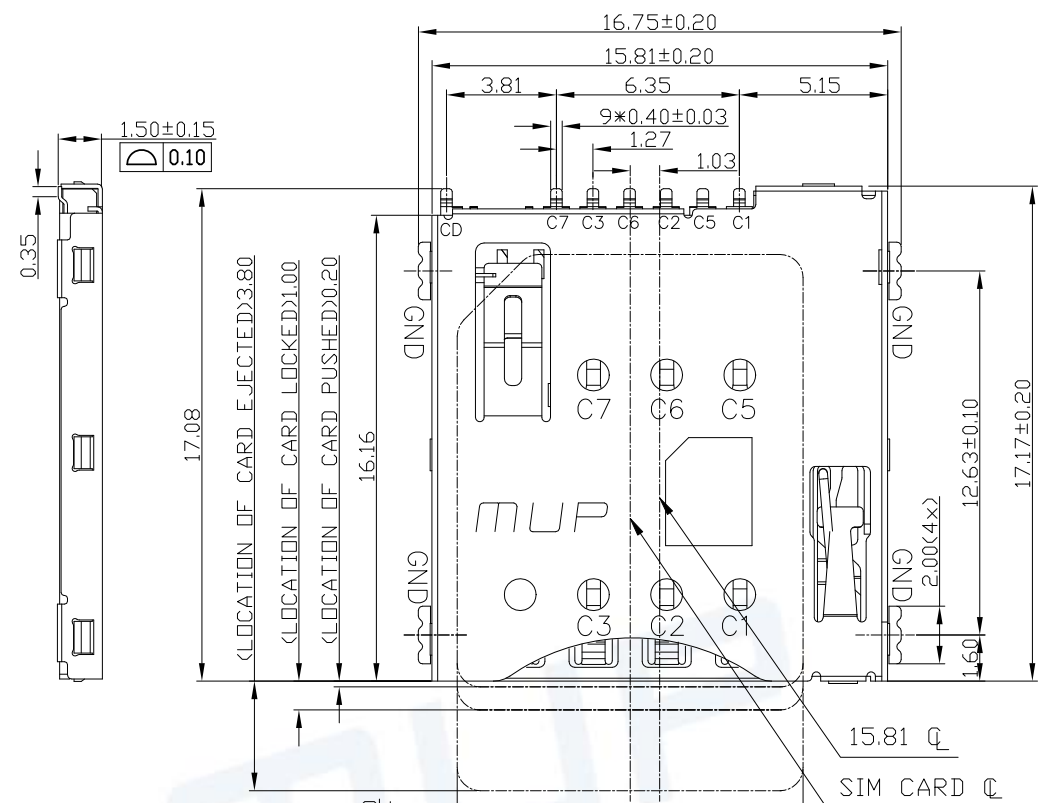


REV.	DESCRIPTION OF REVISIONS	APPR.	CHKD.	DRAW.	DATE
△	NEW			Henry	2017/06/23
△	Original Model C792-3			Henry	2023/10/20



PAD AREA  
 CONNECTOR OUTLINE COMPONENT SIDE(TOLERANCE ±0.05)  
 NO PATTERN AND VIA HOLE IN THIS AREA

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	SPRING	1	SWP	
6	GUIDE	1	Hi-temp Thermoplastic	Black UL94V-0
7	LINK	1	Stainless Steel	

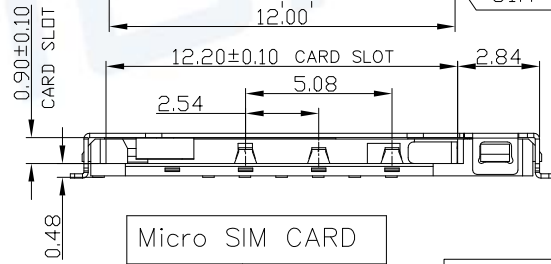
**TECHNICAL CHARACTERISTICS**

**1.General Characteristics**  
 Dimensions: 15.81LX17.17WX1.50H mm  
 Weight: Approx 0.4±0.1g  
 Durability: 1500 cycles min.

**2.Electrical Characteristics**  
 Contact resistance;  
 Date Contact: 150mΩ max  
 CD Switch: 500mΩ max  
 Insulation resistance: >1000MΩ/500V DC

**3.Solderability**  
 Vapor phase: 215°C, 30sec.Max  
 IR reflow: 260°C, 5sec.Max  
 Manual soldering: 370°C, 3sec.Max

**4.Environmental Characteristics**  
 Operating temperature: -40°C~+85°C  
 Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

**MUP**® MUP INDUSTRIAL CO.,LTD.

NAME: <b>MicroSIM Card Connector</b>	
MODEL NO: <b>MUP-C7092-03</b>	
TYPE : <b>H1.50 6PIN Normally Cloes</b>	
PROJ.	DWG NO.:
UNIT	DWG-C7092-03-01
SCALE	SHEET
mm	1/1
1:1	REVISION
CUSTOMER DRAWING	2

APPROVAL	Simon Jun.23.2017
CHECKED	Henry Jun.23.2017
DRAWN	Henry Jun.23.2017